

5mm Cylindrical Without Flange Type  
Full Color Blinking LEDs  
Technical Data Sheet

Part No.: DL-F506RGBMA-F1

# Double Light

## ◆ Features

1. Available on tape and reel.
2. Single lamp with 3 original colors (red, green and blue).
3. Designed for bonding with LED chip.
4. Triple chips embedded.
5. Multiple colors compose full spectrums.
6. Electricity control IC embedded.
7. Lens size with 5mm / 8mm / 10mm options.
8. High intensity.
9. Viewing Angles: 60°.
10. Fancy, fun, hottest in the market.
11. Operating voltage range: 3.00~5.50V DC.
12. Blinking frequency: 0.07Hz ( $V_{DD}=4.50V$ ).
13. Frequency tolerance:  $\pm 20\%$ .
14. The product itself will remain within RoHS compliant Version.

## ◆ Descriptions

1. The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
2. The Pure Green source color devices are made with InGaN on Sapphire substrate Light Emitting Diode.
3. The Blue source color devices are made with InGaN on Sapphire substrate Light Emitting Diode.

## ◆ Benefits:

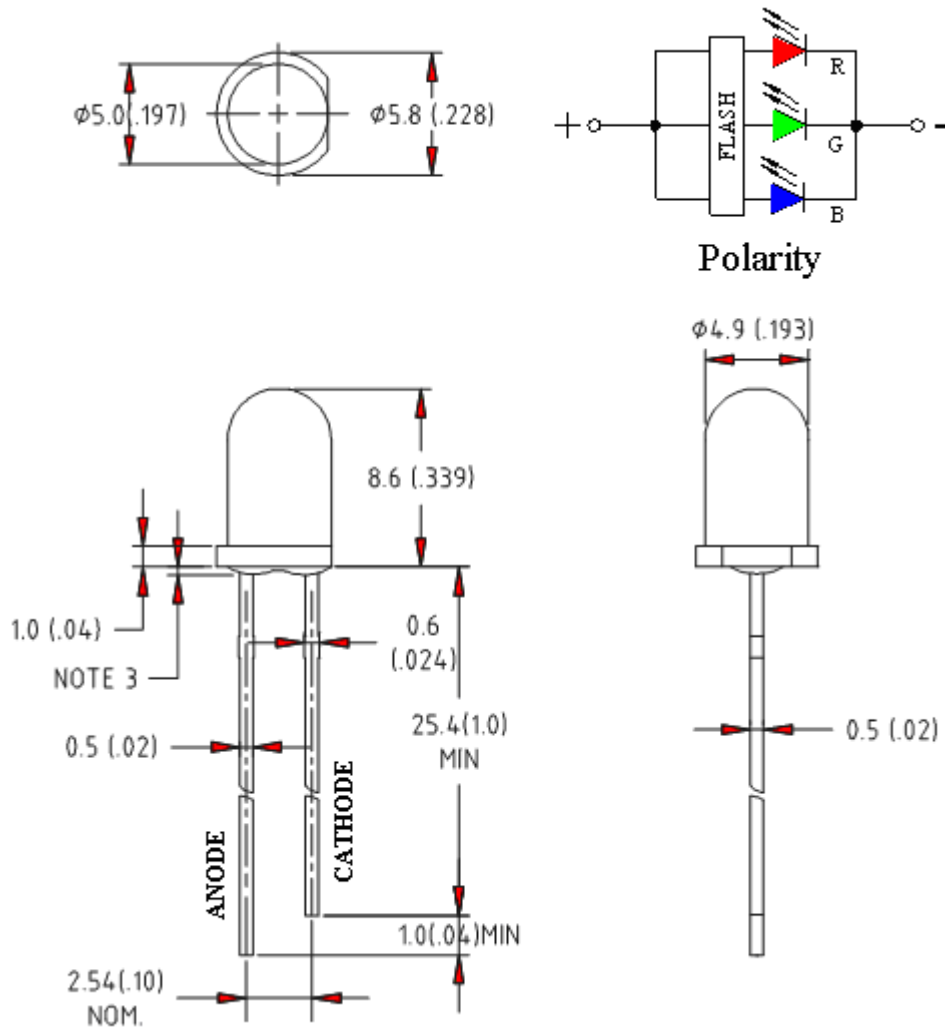
1. New trend creations.
2. Low energy consumptions.
3. Low maintenance costs.
4. High application design flexibility.
5. High reliability.

## ◆ Applications:

1. Status indicators.
2. Commercial use.
3. Advertising Signs.
4. Toys / sports utilities.
5. Miniature key chains.
6. Effect Lights.
7. Display / decoration lights.
8. Electronic displays and signals.
9. Interior decoration lights.
10. Indicator lights.
11. Solar energy lights / garden lights.
12. Monitor.
13. Telephone.
14. Computer.
15. Circuit board

# Double Light

## ◆ Package Dimension:



Part No.	Chip Material		Lens Color	Source Color
DL-F506RGBMA-F1	R	AlGaInP	White Diffused	Hyper Red
	G	InGaN		Pure Green
	B	InGaN		Blue

### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25\text{mm}$  (.010") unless otherwise noted.
3. Protruded resin under flange is 1.00mm (.039") max.
4. Specifications are subject to change without notice.

# Double Light

## ◆ Absolute Maximum Ratings at Ta=25°C

Parameters	Symbol	Max.	Unit
Power Dissipation (Per Chip)	PD	200	mW
Peak Forward Current (Per Chip) (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	100	mA
Forward Current	IF	80	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	1000	V
Operating Temperature Range	Topr	-40°C to +85°C	
Storage Temperature Range	Tstg	-40°C to +100°C	
Lead Soldering Temperature [4mm (.157") From Body]	Tsld	260°C for 5 Seconds	

## Electrical Optical Characteristics at Ta=25°C

Parameters	Symbol	Emitting Color	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity *	IV	Red	300	600	---	mcd	V <sub>DD</sub> =4.50V (Note 1)
		Green	550	1050	---		
		Blue	200	500	---		
Viewing angle	2θ <sub>1/2</sub>		---	60	---	Deg	V <sub>DD</sub> =4.50V (Note 2)
Peak Emission Wavelength	λ <sub>p</sub>	Red	---	632	---	nm	V <sub>DD</sub> =4.50V
		Green	---	520	---		
		Blue	---	468	---		
Dominant Wavelength	λ <sub>d</sub>	Red	---	624	---	nm	V <sub>DD</sub> =4.50V (Note 3)
		Green	---	525	---		
		Blue	---	470	---		
Spectral Line Half-Width	Δλ	Red	---	20	---	nm	IF=20mA (Per Chip)
		Green	---	35	---		
		Blue	---	25	---		
Blinking Frequency	F		---	0.07	---	Hz	V <sub>DD</sub> =4.50V
Frequency tolerance	Fled		---	±20%	---	Hz	V <sub>DD</sub> =4.50V
Operating Voltage	VF		3.00	4.50	5.50	V	
Reverse Current	IR		---	---	50	μA	V <sub>R</sub> =5V

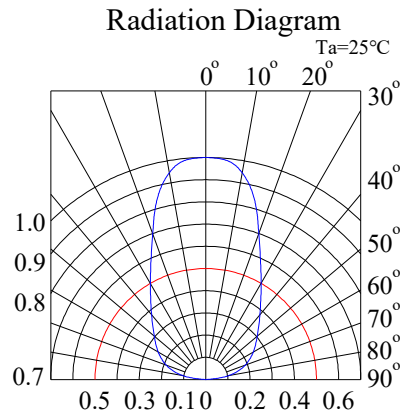
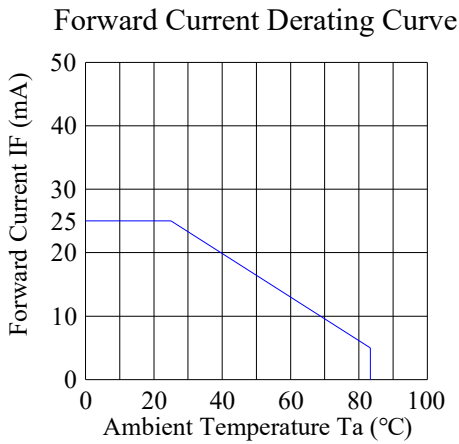
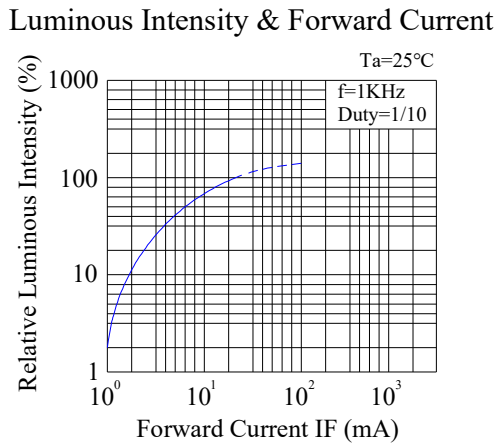
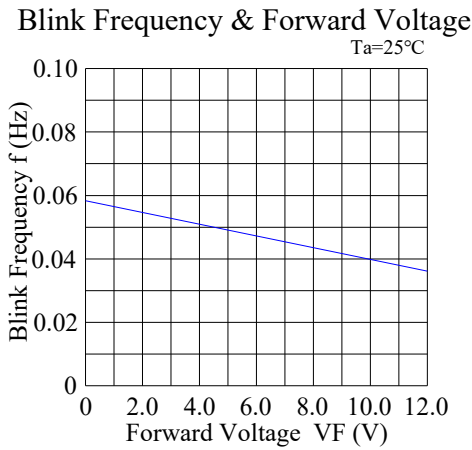
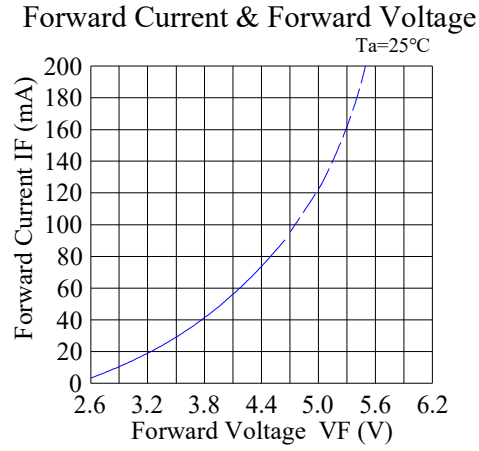
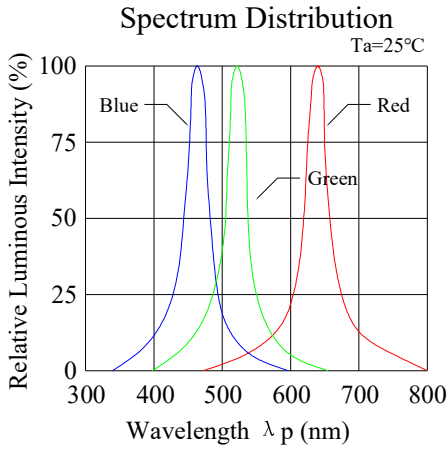
### Notes:

- Luminous Intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- θ<sub>1/2</sub> is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- All specs and applications shown above subject to change without prior notice.

# Double Light

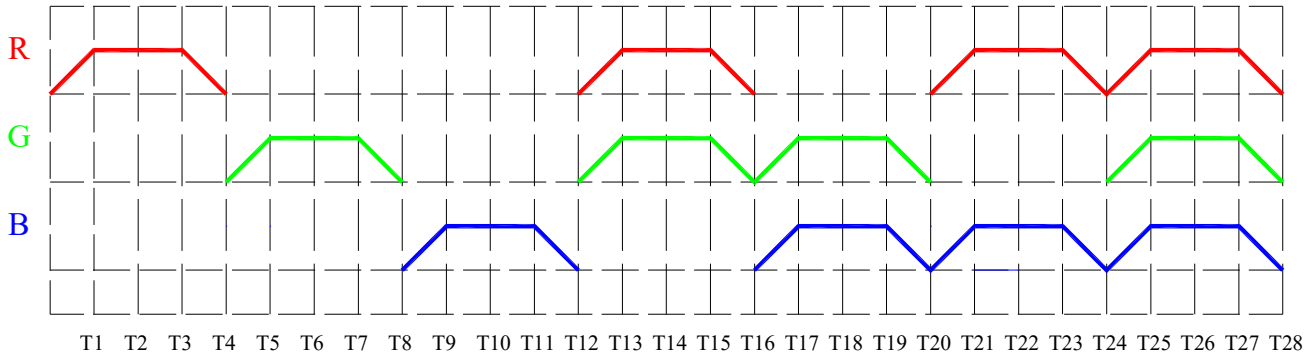
## ◆ Typical Electrical / Optical Characteristics Curves (For Chips)

(25°C Ambient Temperature Unless Otherwise Noted)



# Double Light

## ◆ Flash Diagram of One Cycle Time:



## ◆ Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

### 1) Test Items and Results:

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat	JEITA ED-4701 300 302	Tsld=260±5 °C, 10sec 3mm from the base of the epoxy bulb	1 time	0/100
Solder ability	JEITA ED-4701 300 303	Tsld=235±5 °C, 5sec (using flux)	1time over 95%	0/100
Thermal Shock	JEITA ED-4701 300 307	0 °C~100 °C 15sec, 15sec	100 cycles	0/100
Temperature Cycle	JEITA ED-4701 100 105	-40 °C~25 °C~100 °C~25 °C 30min,5min,30min,5min	100 cycles	0/100
Moisture Resistance Cycle	JEITA ED-4701 200 203	25 °C~65 °C~-10 °C 90%RH 24hrs/1cycle	10 cycles	0/100
High Temperature Storage	JEITA ED-4701 200 201	Ta=100 °C	1000hrs	0/100
Terminal Strength (Pull test)	JEITA ED-4701 400 401	Load 10N (1kgf) 10±1sec	No noticeable damage	0/100
Terminal Strength (bending test)	JEITA ED-4701 400 401	Load 5N (0.5kgf) 0°~90°~0° bend 2 times	No noticeable damage	0/100
Temperature Humidity Storage	JEITA ED-4701 100 103	Ta=60 °C, RH=90%	1000hrs	0/100
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40 °C	1000hrs	0/100
Steady State Operating Life		Ta=25 °C, IF=80mA	1000hrs	0/100
Steady State Operating Life of High Humidity Heat		Ta=60 °C, RH=90%, IF=80mA	500hrs	0/100
Steady State Operating Life of Low Temperature		Ta=-30 °C, IF=100mA	1000hrs	0/100

# Double Light

## ◆ Please read the following notes before using the product:

### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

### 3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

### 5. Caution in ESD

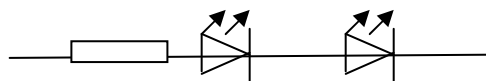
Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices equipment and machinery must be properly grounded.

### 6. Propose operation method:

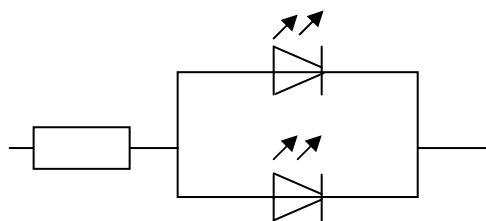
6.1 The DC drive current of LED should be between 10 to 20mA no matter for single LED or multiple LEDs.

#### 6.2 Drive circuit:

##### A. series connection



##### B. parallel way



6.3 The pulse will destroy the fixed inner connection of LED, so the circuit must be designed carefully. When circuit open or close, LED will not be assaulted over-pressed (over-flow).

## **Double Light**

6.4 In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, we should know well about the drive method and condition of the application. If there is no special requirement from customer, we will ensure the uniformity of LEDs at 20mA binning.

6.5 If want to have the uniform luminance and color, please use the same binning current with our company. And avoid using intermix to cause the differences of luminance and color.